



# STB30N65M5, STF30N65M5, STI30N65M5 STP30N65M5, STW30N65M5

N-channel 650 V, 0.125  $\Omega$  22 A, MDmesh™ V Power MOSFET  
D<sup>2</sup>PAK, TO-220FP, I<sup>2</sup>PAK, TO-220, TO-247

## Features

| Order codes | $V_{DSS}$ @ $T_{JMAX}$ | $R_{DS(on)}$ max. | $I_D$               |
|-------------|------------------------|-------------------|---------------------|
| STB30N65M5  | 710 V                  | < 0.139 $\Omega$  | 22 A                |
| STF30N65M5  | 710 V                  | < 0.139 $\Omega$  | 22 A <sup>(1)</sup> |
| STI30N65M5  | 710 V                  | < 0.139 $\Omega$  | 22 A                |
| STP30N65M5  | 710 V                  | < 0.139 $\Omega$  | 22 A                |
| STW30N65M5  | 710 V                  | < 0.139 $\Omega$  | 22 A                |

1. Limited only by maximum temperature allowed

- Worldwide best  $R_{DS(on)}$ \*area
- Higher  $V_{DSS}$  rating
- Excellent switching performance
- Easy to drive
- 100% avalanche tested
- High dv/dt capability

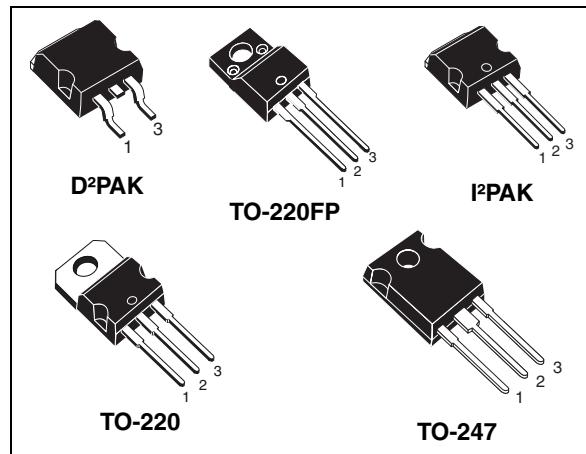
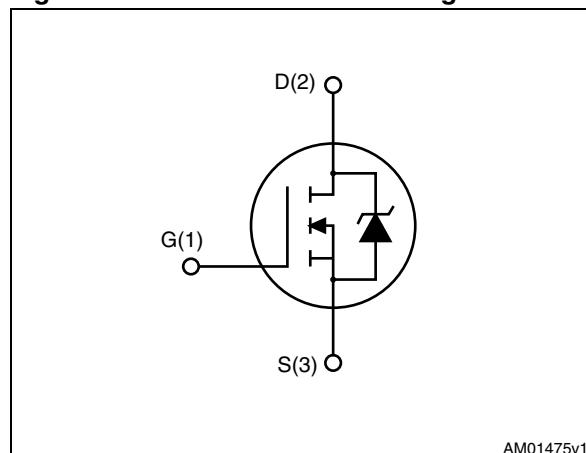


Figure 1. Internal schematic diagram



AM01475v1

## Applications

- Switching applications

## Description

These devices are N-channel MDmesh™ V Power MOSFETs based on an innovative proprietary vertical process technology, which is combined with STMicroelectronics' well-known PowerMESHTM horizontal layout structure. The resulting product has extremely low on-resistance, which is unmatched among silicon-based Power MOSFETs, making it especially suitable for applications which require superior power density and outstanding efficiency.

Table 1. Device summary

| Order codes | Marking | Package            | Packaging     |
|-------------|---------|--------------------|---------------|
| STB30N65M5  | 30N65M5 | D <sup>2</sup> PAK | Tape and reel |
| STF30N65M5  | 30N65M5 | TO-220FP           | Tube          |
| STI30N65M5  | 30N65M5 | I <sup>2</sup> PAK | Tube          |
| STP30N65M5  | 30N65M5 | TO-220             | Tube          |
| STW30N65M5  | 30N65M5 | TO-247             | Tube          |

## Contents

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# 1 Electrical ratings

**Table 2. Absolute maximum ratings**

| Symbol         | Parameter  | Value  |                   | Unit |
|----------------|--|--|-------------------|------|
|                |  | TO-220, D <sup>2</sup> PAK<br>TO-247, I <sup>2</sup> PAK | TO-220FP          |      |
| $V_{GS}$       | Gate-source voltage  | $\pm 25$   |                   | V    |
| $I_D$          | Drain current (continuous) at $T_C = 25^\circ\text{C}$   | 22   | 22 <sup>(1)</sup> | A    |
| $I_D$          | Drain current (continuous) at $T_C = 100^\circ\text{C}$  | 13   | 13 <sup>(1)</sup> | A    |
| $I_{DM}^{(2)}$ | Drain current (pulsed)   | 88   | 88 <sup>(1)</sup> | A    |
| $P_{TOT}$      | Total dissipation at $T_C = 25^\circ\text{C}$  | 140  | 30                | W    |
| $I_{AR}$       | Max current during repetitive or single pulse avalanche (pulse width limited by $T_{JMAX}$ )                           | 7  |                   | A    |
| $E_{AS}$       | Single pulse avalanche energy (starting $T_j = 25^\circ\text{C}$ , $I_D = I_{AR}$ , $V_{DD} = 50\text{V}$ )            | 500  |                   | mJ   |
| $dv/dt^{(3)}$  | Peak diode recovery voltage slope  | 15   |                   | V/ns |
| $V_{ISO}$      | Insulation withstand voltage (RMS) from all three leads to external heat sink ( $t=1\text{ s}; T_C=25^\circ\text{C}$ ) | 2500   |                   | V    |
| $T_{stg}$      | Storage temperature  | - 55 to 150  |                   | °C   |
| $T_j$          | Max. operating junction temperature  | 150  |                   | °C   |

1. Limited only by maximum temperature allowed
2. Pulse width limited by safe operating area
3.  $I_{SD} \leq 21\text{ A}$ ,  $dI/dt = 400\text{ A}/\mu\text{s}$ ,  $V_{Peak} < V_{(BR)DSS}$

**Table 3. Thermal data**

| Symbol         | Parameter                                      | Value              |          |                    |        |        | Unit |
|----------------|--|--------------------|----------|--------------------|--------|--------|------|
|                |  | D <sup>2</sup> PAK | TO-220FP | I <sup>2</sup> PAK | TO-220 | TO-247 |      |
| $R_{thj-case}$ | Thermal resistance junction-case max           | 0.83               | 3.6      | 0.83               |        | °C/W   |      |
| $R_{thj-amb}$  | Thermal resistance junction-ambient max        |                    |          | 62.5               |        | 50     | °C/W |
| $R_{thj-pcb}$  | Thermal resistance junction-pcb max            | 30                 |          |                    |        |        | °C/W |
| $T_I$          | Maximum lead temperature for soldering purpose |                    |          | 300                |        |        | °C   |

## 2 Electrical characteristics

( $T_C = 25^\circ\text{C}$  unless otherwise specified)

**Table 4. On /off states**

| Symbol                      | Parameter  | Test conditions   | Min. | Typ.  | Max.     | Unit                           |
|-----------------------------|--|---|------|-------|----------|--------------------------------|
| $V_{(\text{BR})\text{DSS}}$ | Drain-source breakdown voltage ( $V_{GS} = 0$ )  | $I_D = 1 \text{ mA}$  | 650  |       |          | V                              |
| $I_{\text{DSS}}$            | Zero gate voltage drain current ( $V_{GS} = 0$ ) | $V_{DS} = 650 \text{ V}$<br>$V_{DS} = 650 \text{ V}, T_C = 125^\circ\text{C}$ |      |       | 1<br>100 | $\mu\text{A}$<br>$\mu\text{A}$ |
| $I_{\text{GSS}}$            | Gate-body leakage current ( $V_{DS} = 0$ )       | $V_{GS} = \pm 25 \text{ V}$   |      |       | 100      | nA                             |
| $V_{GS(\text{th})}$         | Gate threshold voltage                           | $V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$                                      | 3    | 4     | 5        | V                              |
| $R_{\text{DS}(\text{on})}$  | Static drain-source on resistance                | $V_{GS} = 10 \text{ V}, I_D = 11 \text{ A}$                                   |      | 0.125 | 0.139    | $\Omega$                       |

**Table 5. Dynamic**

| Symbol   | Parameter   | Test conditions  | Min. | Typ.            | Max. | Unit           |
|--|---|--|------|-----------------|------|----------------|
| $C_{\text{iss}}$<br>$C_{\text{oss}}$<br>$C_{\text{rss}}$ | Input capacitance<br>Output capacitance<br>Reverse transfer capacitance | $V_{DS} = 100 \text{ V}, f = 1 \text{ MHz},$<br>$V_{GS} = 0$   | -    | 2880<br>68<br>5 | -    | pF<br>pF<br>pF |
| $C_{o(\text{tr})}^{(1)}$                                 | Equivalent capacitance time related                                     | $V_{GS} = 0, V_{DS} = 0 \text{ to } 520 \text{ V}$   | -    | 190             | -    | pF             |
| $C_{o(\text{er})}^{(2)}$                                 | Equivalent capacitance energy related                                   | $V_{GS} = 0, V_{DS} = 0 \text{ to } 520 \text{ V}$   | -    | 65              | -    | pF             |
| $R_G$  | Intrinsic gate resistance   | $f = 1 \text{ MHz}$ open drain   | -    | 1.6             | -    | $\Omega$       |
| $Q_g$<br>$Q_{gs}$<br>$Q_{gd}$                            | Total gate charge<br>Gate-source charge<br>Gate-drain charge            | $V_{DD} = 520 \text{ V}, I_D = 11 \text{ A},$<br>$V_{GS} = 10 \text{ V}$<br>(see <a href="#">Figure 20</a> ) | -    | 64<br>16<br>25  | -    | nC<br>nC<br>nC |

1.  $C_{\text{oss eq}}$  time related is defined as a constant equivalent capacitance giving the same charging time as  $C_{\text{oss}}$  when  $V_{DS}$  increases from 0 to 80%  $V_{DSS}$
2.  $C_{\text{oss eq}}$  energy related is defined as a constant equivalent capacitance giving the same stored energy as  $C_{\text{oss}}$  when  $V_{DS}$  increases from 0 to 80%  $V_{DSS}$

**Table 6. Switching times**

| Symbol              | Parameter           | Test conditions  | Min. | Typ. | Max | Unit |
|---------------------|---------------------|--|------|------|-----|------|
| $t_{d(\text{off})}$ | Turn-off delay time | $V_{DD} = 400 \text{ V}, I_D = 14 \text{ A}, R_G = 4.7 \Omega, V_{GS} = 10 \text{ V}$<br>(see <i>Figure 21</i> ) | -    | 50   | -   | ns   |
| $t_r$               | Rise time           |  |      | 8    | -   | ns   |
| $t_c$               | Cross time          |  |      | 20   | -   | ns   |
| $t_f$               | Fall time           |  |      | 10   | -   | ns   |

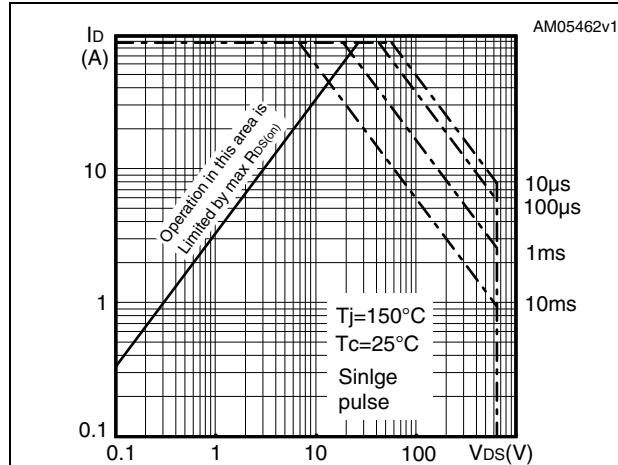
**Table 7. Source drain diode**

| Symbol          | Parameter                     | Test conditions   | Min. | Typ. | Max. | Unit          |
|-----------------|-------------------------------|---|------|------|------|---------------|
| $I_{SD}$        | Source-drain current          |   | -    | 22   | 88   | A             |
| $I_{SDM}^{(1)}$ | Source-drain current (pulsed) |   |      |      |      |               |
| $V_{SD}^{(2)}$  | Forward on voltage            | $I_{SD} = 22 \text{ A}, V_{GS} = 0$   | -    | -    | 1.5  | V             |
| $t_{rr}$        | Reverse recovery time         | $I_{SD} = 22 \text{ A}, di/dt = 100 \text{ A}/\mu\text{s}$<br>$V_{DD} = 60 \text{ V}$ (see <i>Figure 21</i> )                             | -    | 336  | -    | ns            |
| $Q_{rr}$        | Reverse recovery charge       |   |      | 6    | -    | $\mu\text{C}$ |
| $I_{RRM}$       | Reverse recovery current      |   |      | 32   | -    | A             |
| $t_{rr}$        | Reverse recovery time         | $I_{SD} = 22 \text{ A}, di/dt = 100 \text{ A}/\mu\text{s}$<br>$V_{DD} = 60 \text{ V}, T_j = 150^\circ\text{C}$<br>(see <i>Figure 21</i> ) | -    | 395  | -    | ns            |
| $Q_{rr}$        | Reverse recovery charge       |   |      | 7    | -    | $\mu\text{C}$ |
| $I_{RRM}$       | Reverse recovery current      |   |      | 34   | -    | A             |

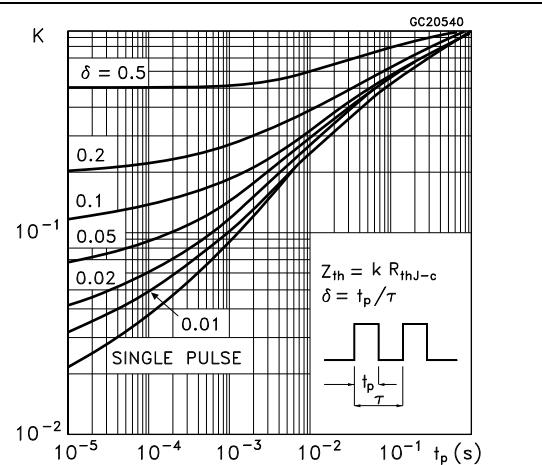
1. Pulse width limited by safe operating area
2. Pulsed: Pulse duration = 300  $\mu\text{s}$ , duty cycle 1.5%

## 2.1 Electrical characteristics (curves)

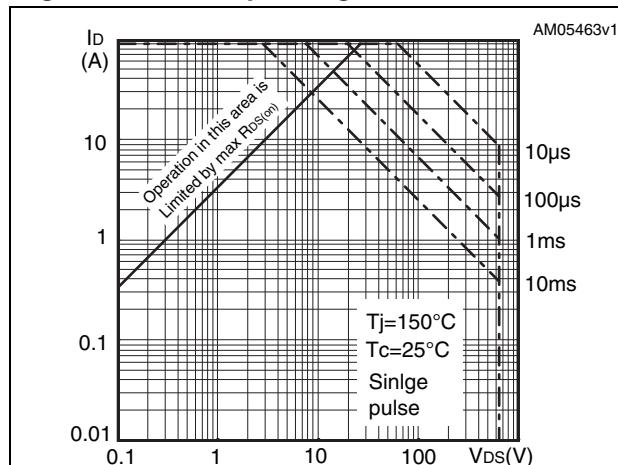
**Figure 2.** Safe operating area for TO-220, D<sup>2</sup>PAK, I<sup>2</sup>PAK



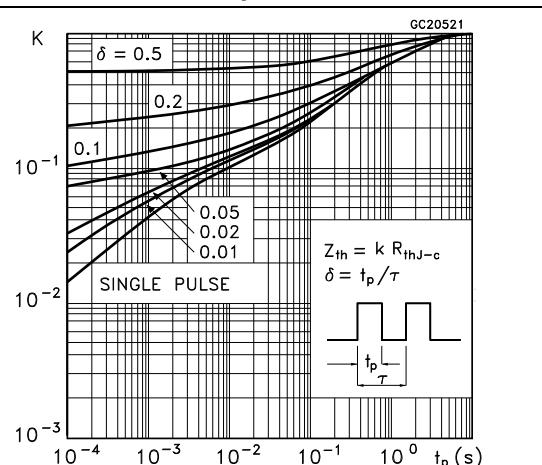
**Figure 3.** Thermal impedance for TO-220, D<sup>2</sup>PAK, I<sup>2</sup>PAK



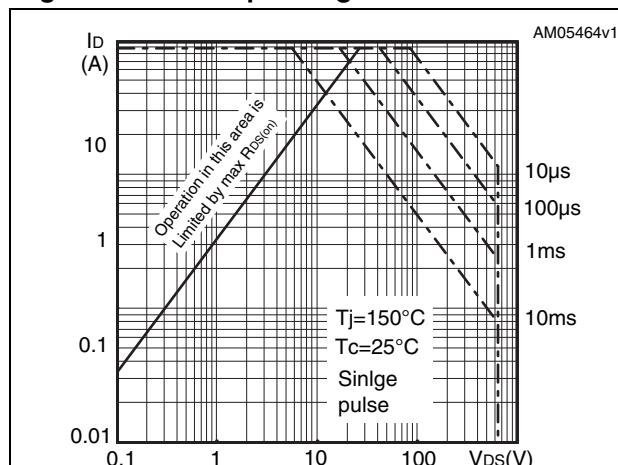
**Figure 4.** Safe operating area for TO-220FP



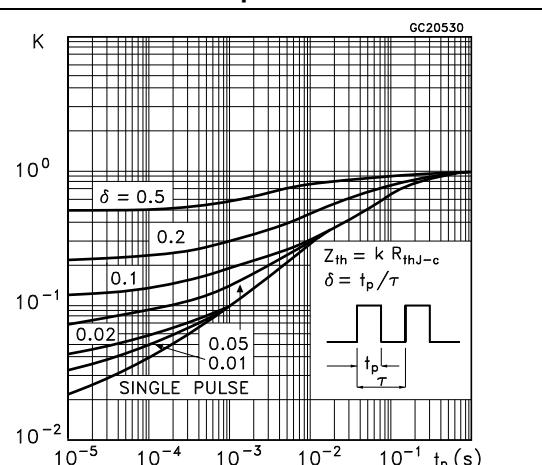
**Figure 5.** Thermal impedance for TO-220FP

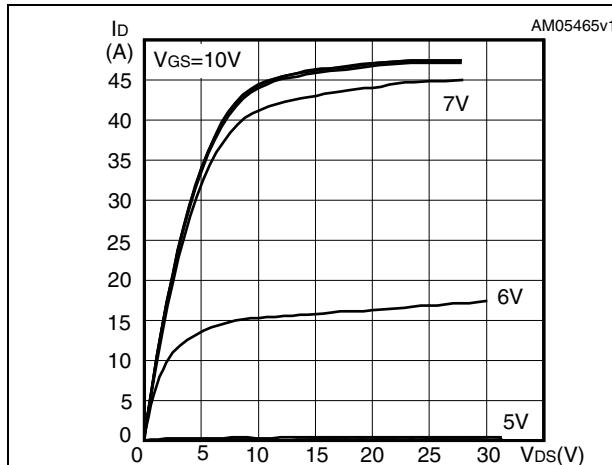
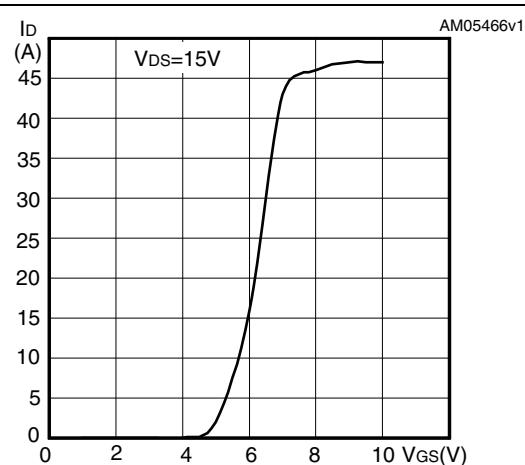
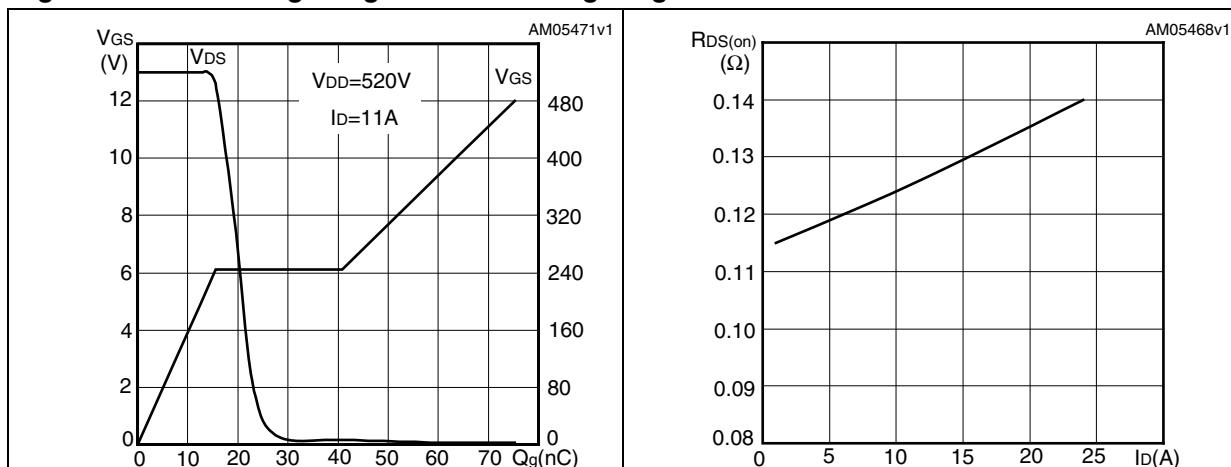
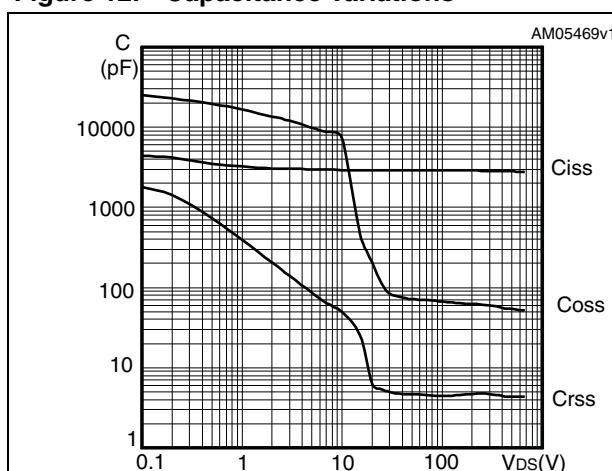
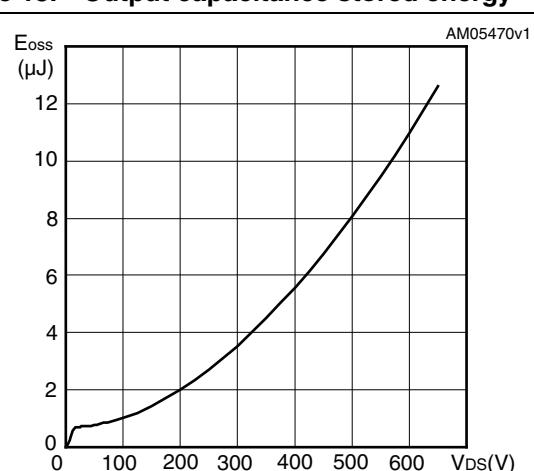


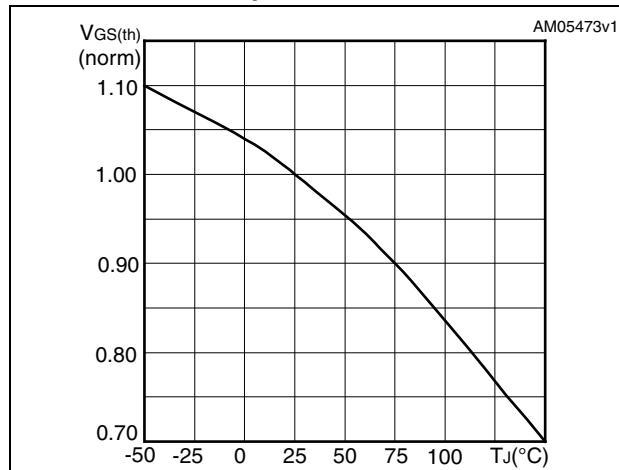
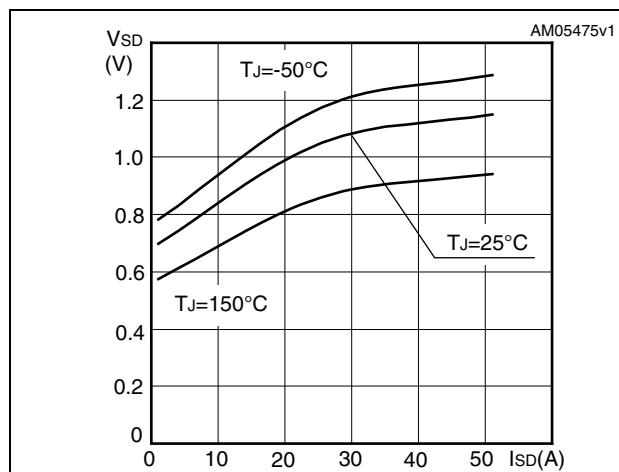
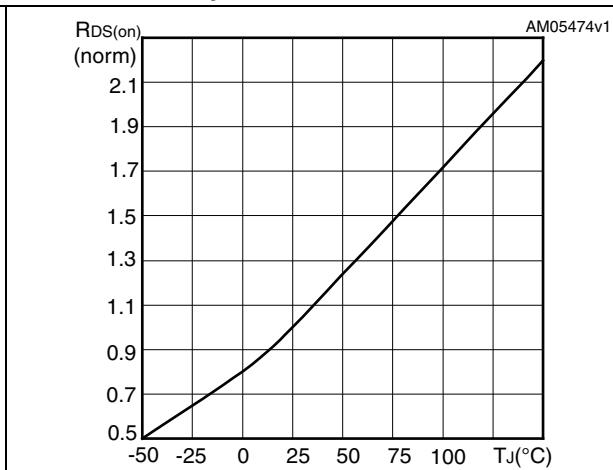
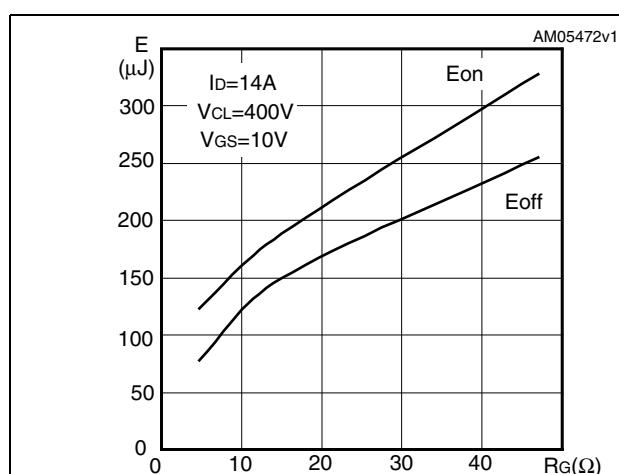
**Figure 6.** Safe operating area for TO-247



**Figure 7.** Thermal impedance for TO-247



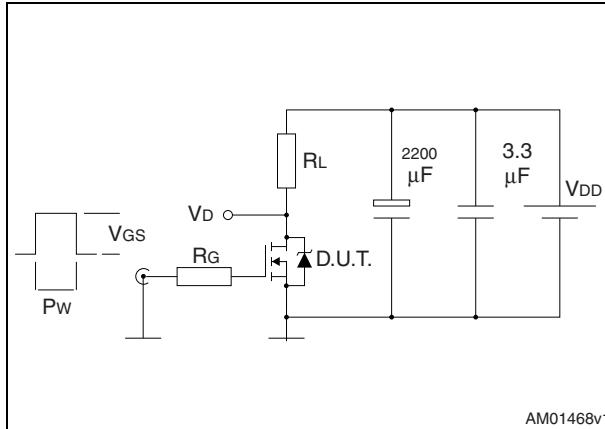
**Figure 8. Output characteristics****Figure 9. Transfer characteristics****Figure 10. Gate charge vs gate-source voltage** **Figure 11. Static drain-source on resistance****Figure 12. Capacitance variations****Figure 13. Output capacitance stored energy**

**Figure 14. Normalized gate threshold voltage vs temperature****Figure 16. Source-drain diode forward characteristics****Figure 17. Normalized B<sub>VDSS</sub> vs temperature****Figure 18. Switching losses vs gate resistance (1)**

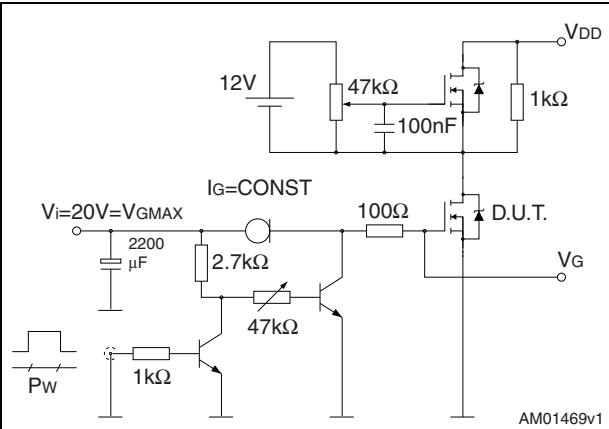
1. Eon including reverse recovery of a SiC diode

### 3 Test circuits

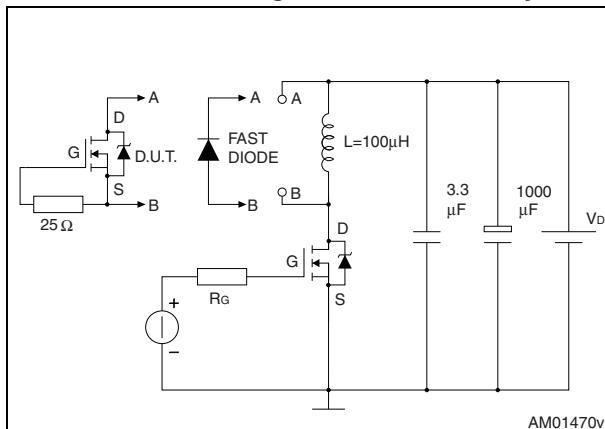
**Figure 19. Switching times test circuit for resistive load**



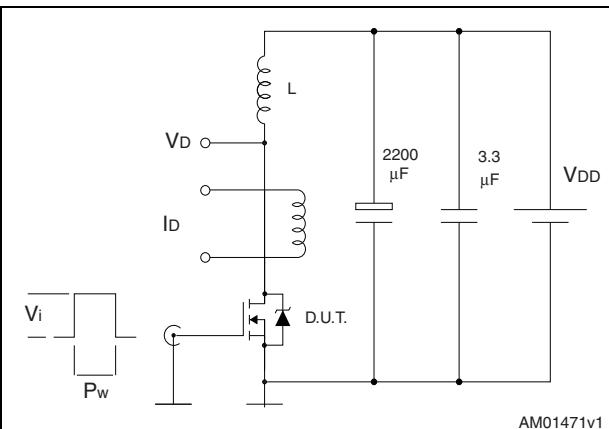
**Figure 20. Gate charge test circuit**



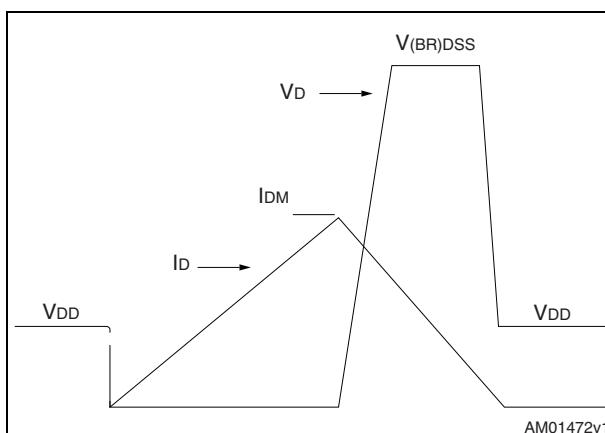
**Figure 21. Test circuit for inductive load switching and diode recovery times**



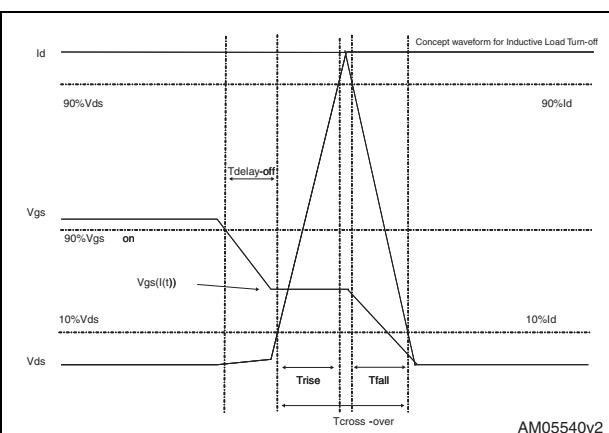
**Figure 22. Unclamped inductive load test circuit**



**Figure 23. Unclamped inductive waveform**



**Figure 24. Switching time waveform**

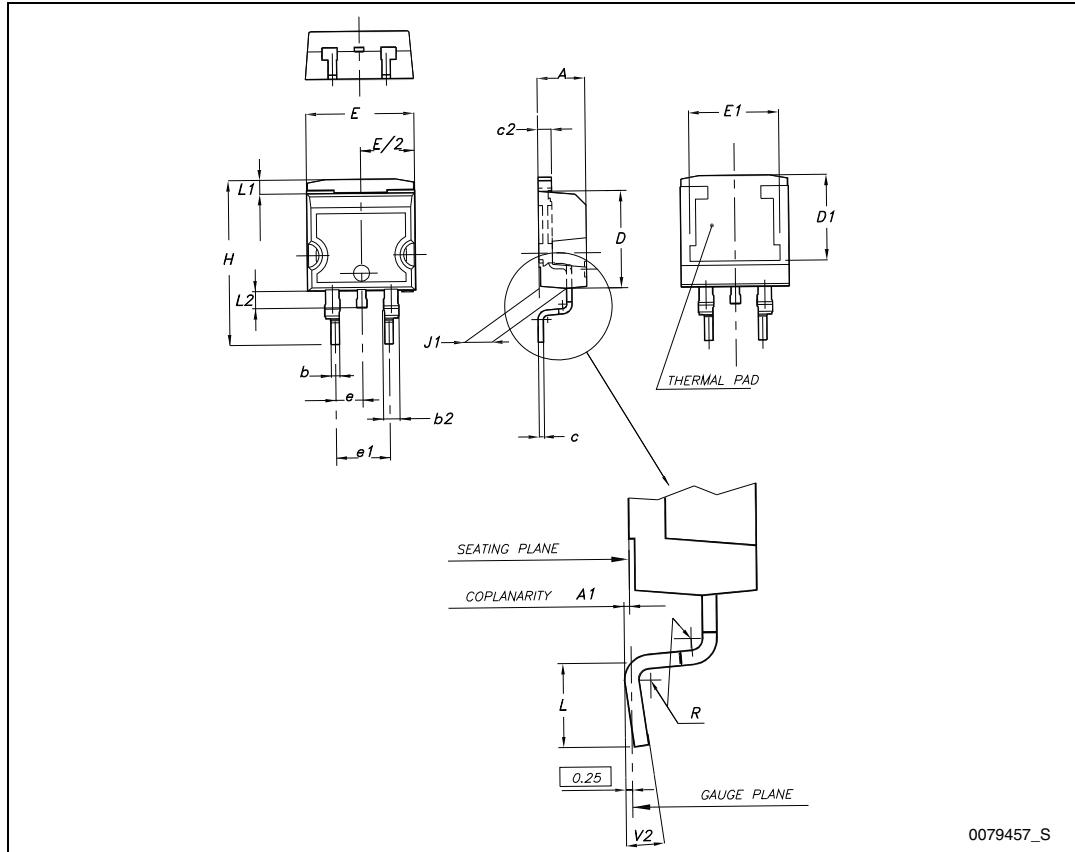


## 4 Package mechanical data

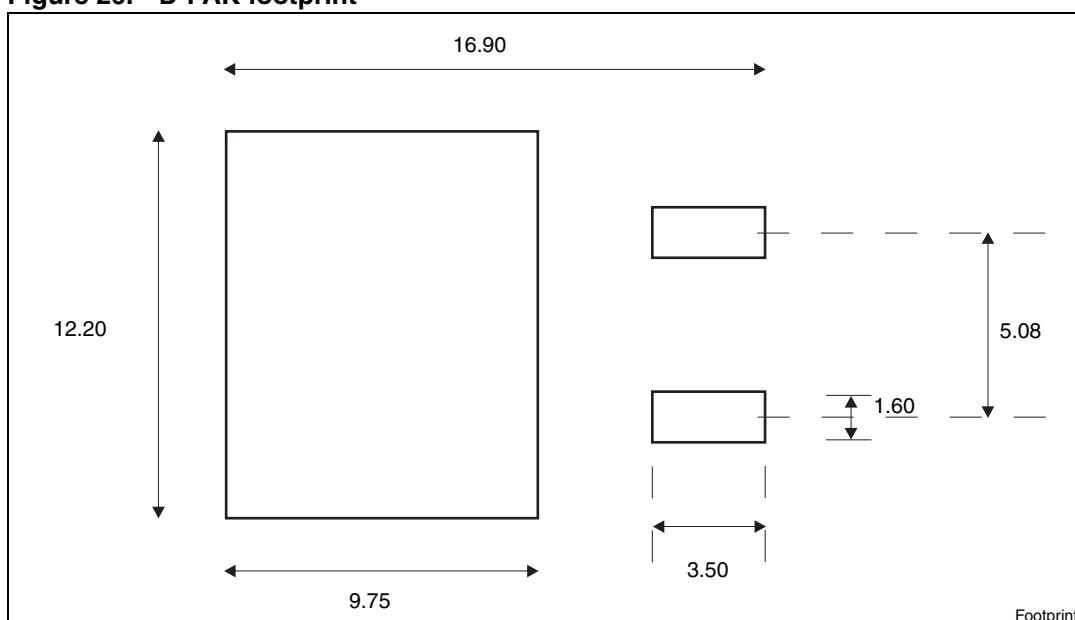
In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com).  
ECOPACKM is an ST trademark.

**Table 8. D<sup>2</sup>PAK (TO-263) mechanical data**

| Dim. | mm   |      |       |
|------|------|------|-------|
|      | Min. | Typ. | Max.  |
| A    | 4.40 |      | 4.60  |
| A1   | 0.03 |      | 0.23  |
| b    | 0.70 |      | 0.93  |
| b2   | 1.14 |      | 1.70  |
| c    | 0.45 |      | 0.60  |
| c2   | 1.23 |      | 1.36  |
| D    | 8.95 |      | 9.35  |
| D1   | 7.50 |      |       |
| E    | 10   |      | 10.40 |
| E1   | 8.50 |      |       |
| e    |      | 2.54 |       |
| e1   | 4.88 |      | 5.28  |
| H    | 15   |      | 15.85 |
| J1   | 2.49 |      | 2.69  |
| L    | 2.29 |      | 2.79  |
| L1   | 1.27 |      | 1.40  |
| L2   | 1.30 |      | 1.75  |
| R    |      | 0.4  |       |
| V2   | 0°   |      | 8°    |

**Figure 25. D<sup>2</sup>PAK (TO-263) drawing**

0079457\_S

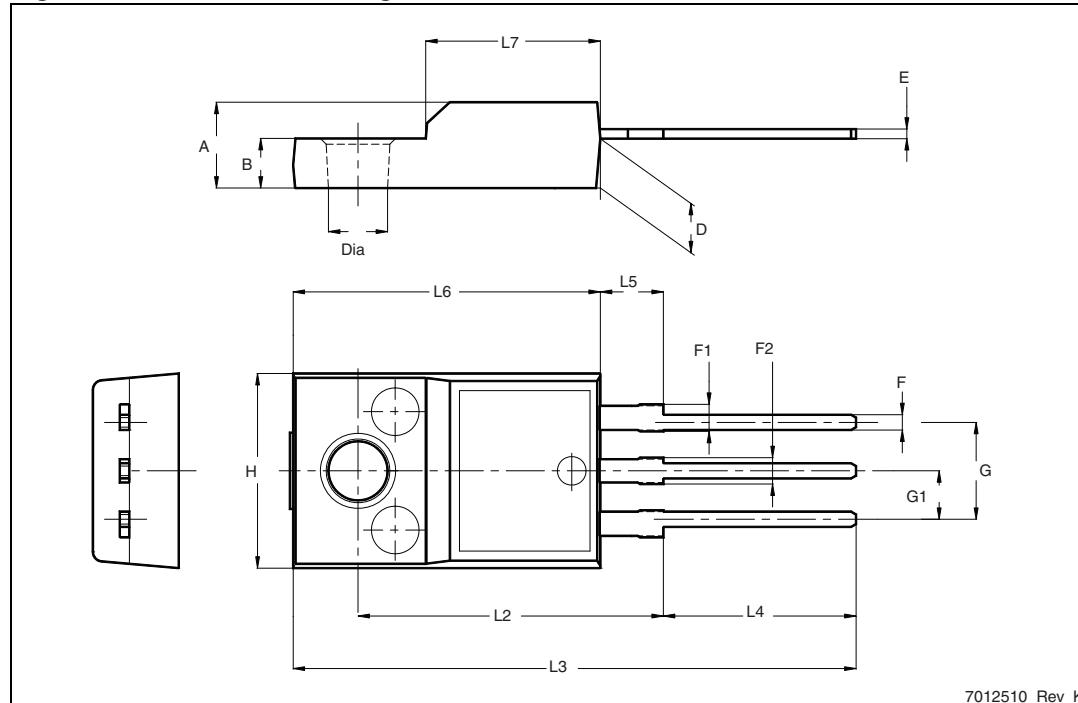
**Figure 26. D<sup>2</sup>PAK footprint<sup>(a)</sup>**

Footprint

a. All dimensions are in millimeters

**Table 9.** TO-220FP mechanical data

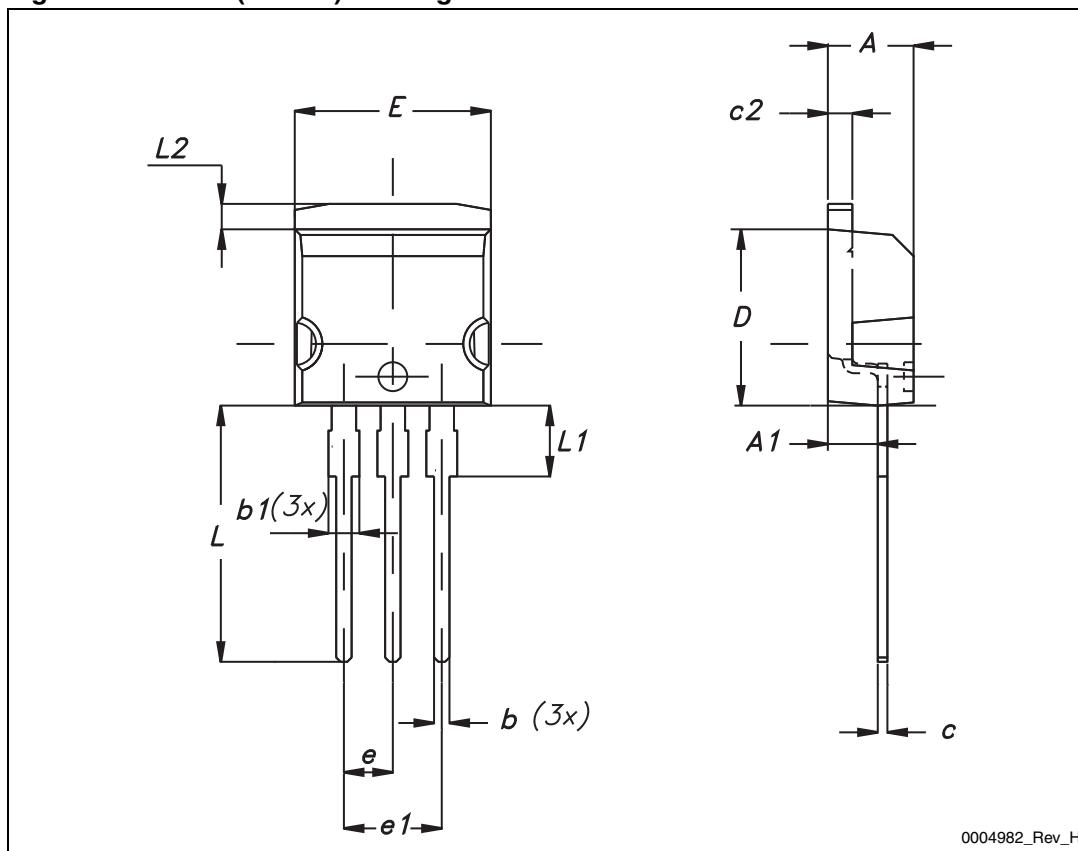
| Dim. | mm   |      |      |
|------|------|------|------|
|      | Min. | Typ. | Max. |
| A    | 4.4  |      | 4.6  |
| B    | 2.5  |      | 2.7  |
| D    | 2.5  |      | 2.75 |
| E    | 0.45 |      | 0.7  |
| F    | 0.75 |      | 1    |
| F1   | 1.15 |      | 1.70 |
| F2   | 1.15 |      | 1.70 |
| G    | 4.95 |      | 5.2  |
| G1   | 2.4  |      | 2.7  |
| H    | 10   |      | 10.4 |
| L2   |      | 16   |      |
| L3   | 28.6 |      | 30.6 |
| L4   | 9.8  |      | 10.6 |
| L5   | 2.9  |      | 3.6  |
| L6   | 15.9 |      | 16.4 |
| L7   | 9    |      | 9.3  |
| Dia  | 3    |      | 3.2  |

**Figure 27.** TO-220FP drawing

7012510\_Rev\_K

Table 10. I<sup>2</sup>PAK (TO-262) mechanical data

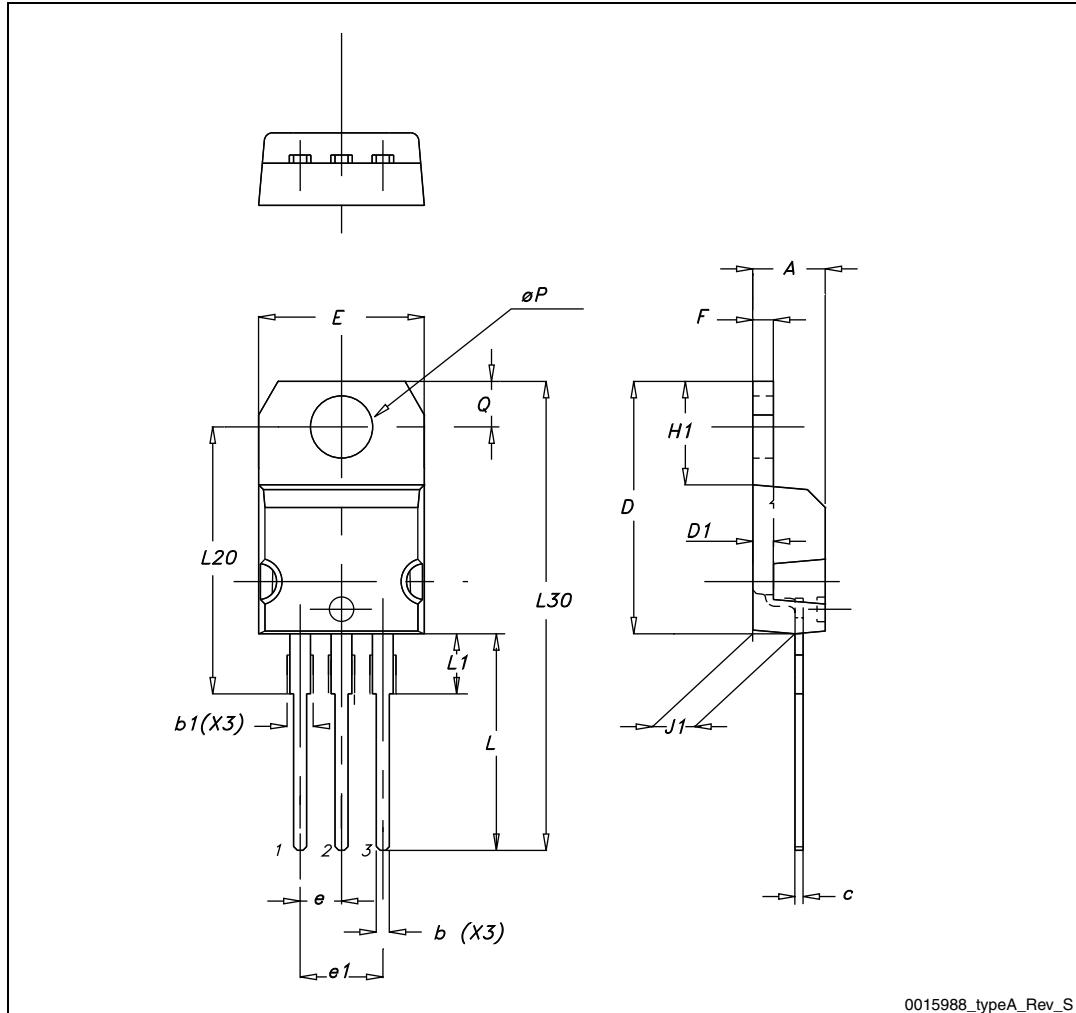
| DIM. | mm.  |     |       |
|------|------|-----|-------|
|      | min. | typ | max.  |
| A    | 4.40 |     | 4.60  |
| A1   | 2.40 |     | 2.72  |
| b    | 0.61 |     | 0.88  |
| b1   | 1.14 |     | 1.70  |
| c    | 0.49 |     | 0.70  |
| c2   | 1.23 |     | 1.32  |
| D    | 8.95 |     | 9.35  |
| e    | 2.40 |     | 2.70  |
| e1   | 4.95 |     | 5.15  |
| E    | 10   |     | 10.40 |
| L    | 13   |     | 14    |
| L1   | 3.50 |     | 3.93  |
| L2   | 1.27 |     | 1.40  |

Figure 28. I<sup>2</sup>PAK (TO-262) drawing

**Table 11.** TO-220 type A mechanical data

| Dim. | mm    |       |       |
|------|-------|-------|-------|
|      | Min.  | Typ.  | Max.  |
| A    | 4.40  |       | 4.60  |
| b    | 0.61  |       | 0.88  |
| b1   | 1.14  |       | 1.70  |
| c    | 0.48  |       | 0.70  |
| D    | 15.25 |       | 15.75 |
| D1   |       | 1.27  |       |
| E    | 10    |       | 10.40 |
| e    | 2.40  |       | 2.70  |
| e1   | 4.95  |       | 5.15  |
| F    | 1.23  |       | 1.32  |
| H1   | 6.20  |       | 6.60  |
| J1   | 2.40  |       | 2.72  |
| L    | 13    |       | 14    |
| L1   | 3.50  |       | 3.93  |
| L20  |       | 16.40 |       |
| L30  |       | 28.90 |       |
| ØP   | 3.75  |       | 3.85  |
| Q    | 2.65  |       | 2.95  |

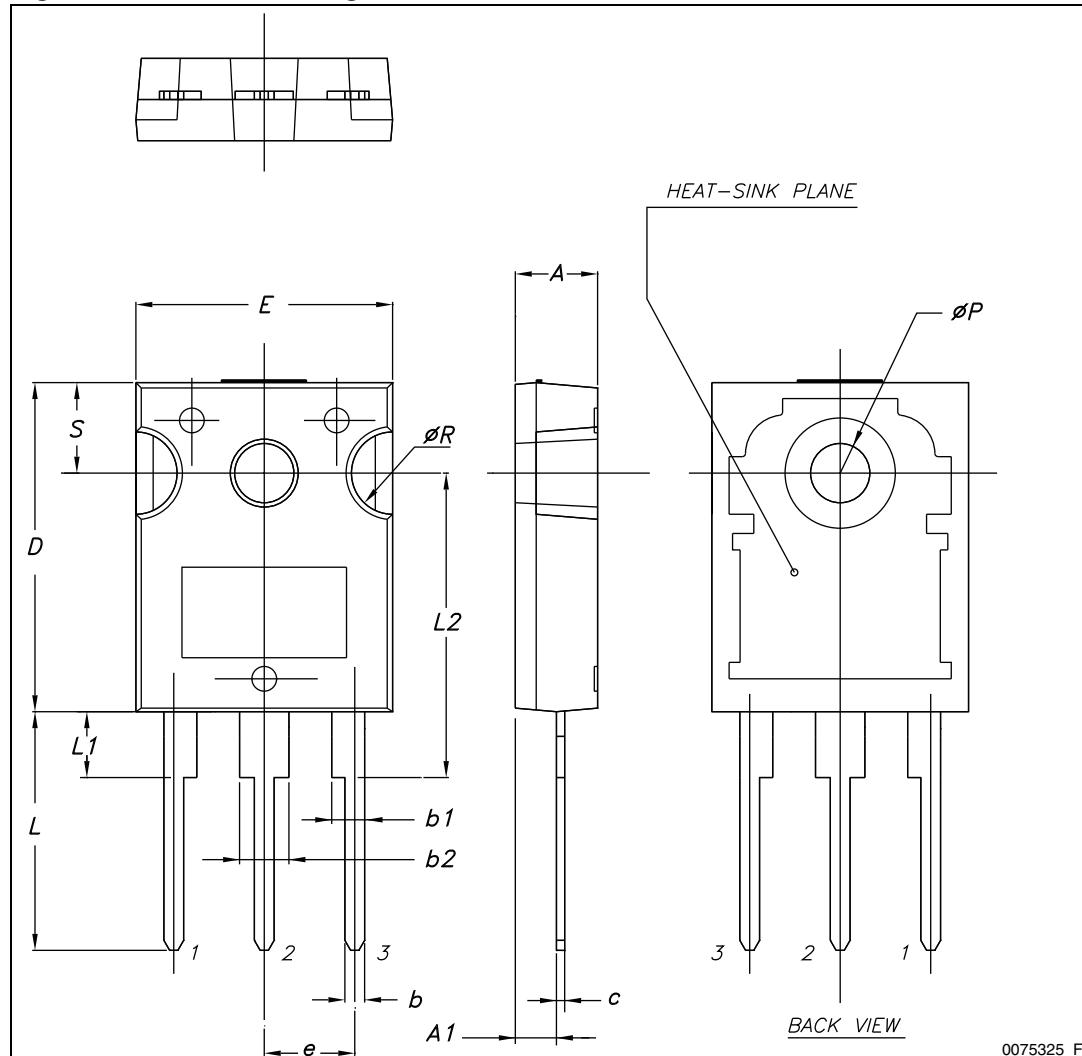
Figure 29. TO-220 type A drawing



**Table 12.** TO-247 mechanical data

| Dim. | mm    |       |       |
|------|-------|-------|-------|
|      | Min.  | Typ.  | Max.  |
| A    | 4.85  |       | 5.15  |
| A1   | 2.20  |       | 2.60  |
| b    | 1.0   |       | 1.40  |
| b1   | 2.0   |       | 2.40  |
| b2   | 3.0   |       | 3.40  |
| c    | 0.40  |       | 0.80  |
| D    | 19.85 |       | 20.15 |
| E    | 15.45 |       | 15.75 |
| e    |       | 5.45  |       |
| L    | 14.20 |       | 14.80 |
| L1   | 3.70  |       | 4.30  |
| L2   |       | 18.50 |       |
| ØP   | 3.55  |       | 3.65  |
| ØR   | 4.50  |       | 5.50  |
| S    |       | 5.50  |       |

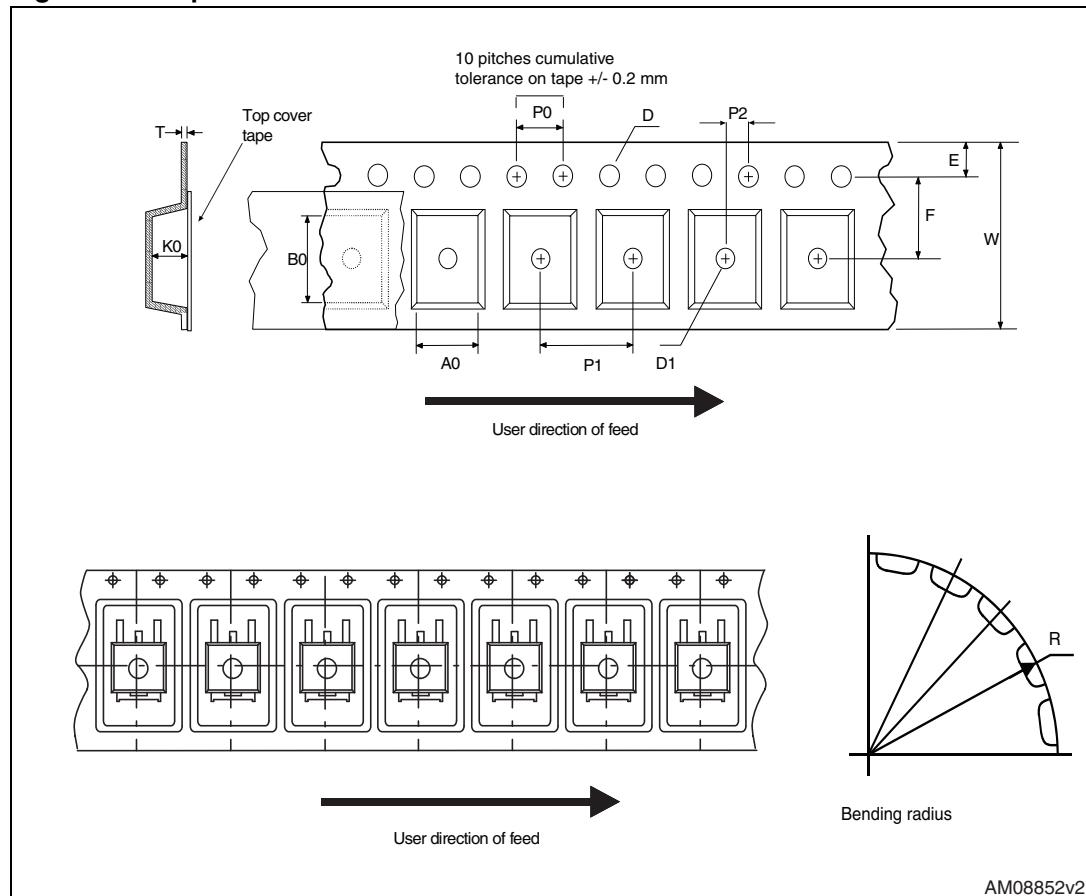
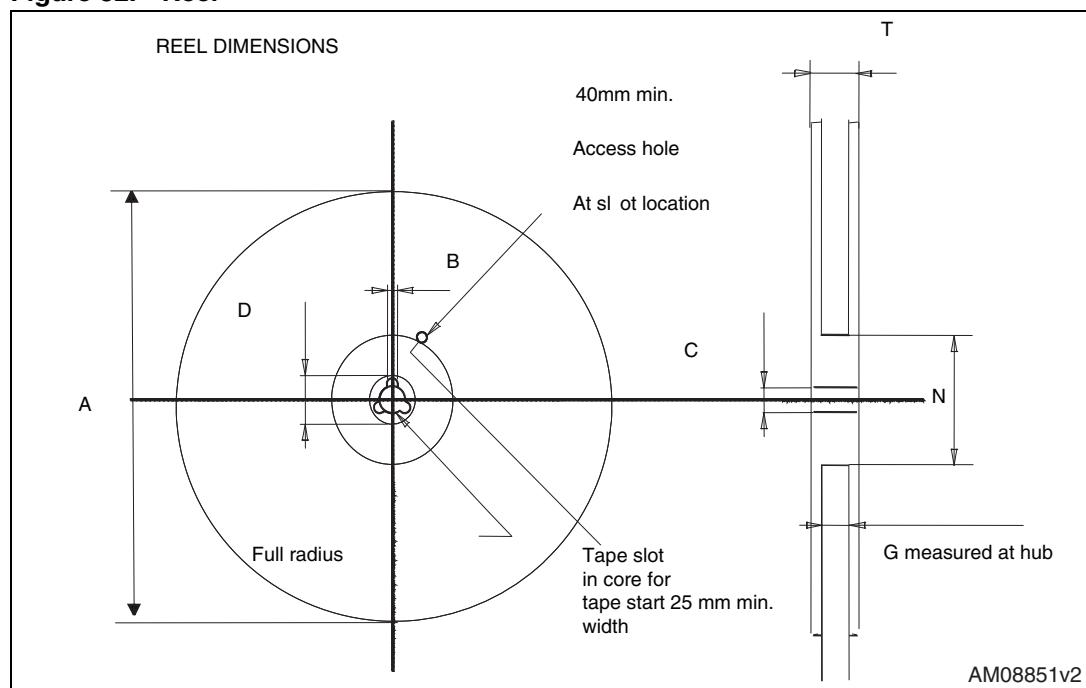
Figure 30. TO-247 drawing



## 5 Packaging mechanical data

**Table 13. D<sup>2</sup>PAK (TO-263) tape and reel mechanical data**

| Tape |      |      | Reel |          |      |
|------|------|------|------|----------|------|
| Dim. | mm   |      | Dim. | mm       |      |
|      | Min. | Max. |      | Min.     | Max. |
| A0   | 10.5 | 10.7 | A    |          | 330  |
| B0   | 15.7 | 15.9 | B    | 1.5      |      |
| D    | 1.5  | 1.6  | C    | 12.8     | 13.2 |
| D1   | 1.59 | 1.61 | D    | 20.2     |      |
| E    | 1.65 | 1.85 | G    | 24.4     | 26.4 |
| F    | 11.4 | 11.6 | N    | 100      |      |
| K0   | 4.8  | 5.0  | T    |          | 30.4 |
| P0   | 3.9  | 4.1  |      |          |      |
| P1   | 11.9 | 12.1 |      | Base qty | 1000 |
| P2   | 1.9  | 2.1  |      | Bulk qty | 1000 |
| R    | 50   |      |      |          |      |
| T    | 0.25 | 0.35 |      |          |      |
| W    | 23.7 | 24.3 |      |          |      |

**Figure 31. Tape****Figure 32. Reel**

## 6 Revision history

**Table 14. Document revision history**

| Date        | Revision | Changes   |
|-------------|----------|---|
| 16-Jan-2009 | 1        | First release   |
| 21-Sep-2009 | 2        | Document status promoted from preliminary data to datasheet.  |
| 22-Sep-2011 | 3        | <p><math>C_{o(er)}</math> and <math>C_{o(tr)}</math> values changed in <a href="#">Table 5: Dynamic Table 6: Switching times</a> parameters updates<br/> <a href="#">Figure 24: Switching time waveform</a> has been corrected<br/>         Minor text changes<br/> <i>Section 4: Package mechanical data</i> has been modified. Added:</p> <ul style="list-style-type: none"> <li>- <a href="#">Table 8: D<sup>2</sup>PAK (TO-263) mechanical data</a>, <a href="#">Figure 25: D<sup>2</sup>PAK (TO-263) drawing</a> and <a href="#">Figure 26: D<sup>2</sup>PAK footprint</a>;</li> <li>- <a href="#">Table 9: TO-220FP mechanical data</a>, and <a href="#">Figure 27: TO-220FP drawing</a>;</li> <li>- <a href="#">Table 10: I<sup>2</sup>PAK (TO-262) mechanical data</a>, and <a href="#">Figure 28: I<sup>2</sup>PAK (TO-262) drawing</a>;</li> <li>- <a href="#">Table 11: TO-220 type A mechanical data</a>, and <a href="#">Figure 29: TO-220 type A drawing</a>;</li> <li>- <a href="#">Table 12: TO-247 mechanical data</a>, and <a href="#">Figure 30: TO-247 drawing</a>;</li> </ul> <p><i>Section 5: Packaging mechanical data</i> has been modified. Added:</p> <ul style="list-style-type: none"> <li>- <a href="#">Table 13: D<sup>2</sup>PAK (TO-263) tape and reel mechanical data</a>, <a href="#">Figure 31: Tape</a> and <a href="#">Figure 32: Reel</a>;</li> </ul> |

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